TENTATIVE

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

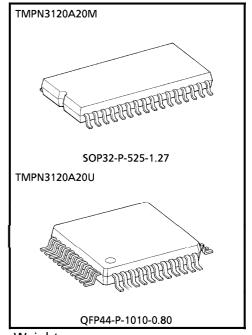
TMPN3120A20M, TMPN3120A20U

Neuron[®] Chip For Distributed Intelligent Control Networks (LonWorks[®])

The Neuron Chip TMPN3120A20M and TMPN3120A20U provides double the performance of previous Neuron Chips. It supports a response time of 3 to 4ms across a LONWORKS Network and has double the input/output (I/O) performance of the previous Neuron Chip in terms of both response time and data transmission speed. Neuron Chips have all the built-in communications and control functions required to implement LONWORKS nodes. These nodes may then be easily integrated into highly-reliable distributed intelligent control networks. The typical functions for this chip are explained below.

FEATURES

- New features (In comparison with TMPN3120FE3M and TMPN3120A20M/U)
 - Enhanced communication port
 - 16-bit A/D converter
 - The package is QFP44-P-1010-0.80 (TMPN3120A20U only)



Weight SOP32-P-525-1.27 : 1.1g (Typ.) QFP44-P-1010-0.80 : 0.6g (Typ.)

The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.

The information contained herein is subject to change without notice.

TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor DOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

The products described in this document are subject to foreign exchange and foreign trade laws.

The information contained herein is presented only as a guide for the applications of our products. No responsibility

- Main features of the 20MHz Neuron Chip (In comparison with the TMPN3120E1M and TMPN3120A20M/U)
 - Increased communication speed

The maximum transmission speed has been increased two-fold. $1.25 \text{Mbps} \rightarrow 2.5 \text{Mbps}$

Shortened response time

The amount of time required from I/O input to I/O output has been greatly reduced. Maximum speed $7ms \rightarrow 3\sim 4ms$

Increased IO object speed

The execution time for all objects has been halved. Example) Serial I/O 9600bps

Parallel I/O 1.2 \(\mu s \) byte

• Development tool support

The current LonBuilder[®] and NodeBuilder[®] development tools can be used to develop applications for the TMPN3120A20M and TMPN3120A20U. Updated symbol table files for the Neuron Chip firmware are available from Toshiba. If your application requires a 20MHz input clock, a utility program available from Echelon may be used to convert the programmer files.

- * The conversion utilities can be obtained from the Echelon Web Site at http://www.echelon.com.
- * Use the 3120 programmer manufactured by Echelon when downloading to the chip.

• I/O Functions

- Eleven programmable I/O pins.
- Two programmable 16-bit timers and counters built in.
- 34 different types of I/O functions to handle a wide range of input and output.
- ROM firmware image containing pre-programmed I/O drivers, greatly simplifying application programs.

Network functions

• Two CPUs for communication protocol processing built in.

The communications and application CPUs execute in parallel.

- Equipped with a built-in LonTalk protocol which supports all seven levels of the OSI reference model with ISO.
- The ROM firmware image contains a complete network operating system, greatly simplifying application programs.
- Built-in twisted-pair wire transceiver with improved common mode and drive current capabilities.
- Equipped with communications modes and communication speeds which support various types of external transceivers.
 - Supports twisted-pair wire, power line, radio (RF), infrared, coaxial cables, and fiber optics.
- Communication port transceiver modes and logical addresses stored within the EEPROM. Can be amended via the network.

- Other functions
 - Application programs are also stored within the EEPROM.
 May be updated by downloading over the network.
 - Built-in watch-dog timer.
 - Each chip has a unique ID number.
 Effective during the logical installation of networks.
 - Low electrical consumption mode supported with a sleep mode.
 - Built in Selectable Reset time

Prolongs the power-ON reset time for at least 50ms and keeps the operation stable during that time. The reset time can be selected 50ms delay mode or 3 clock delay mode by program after the device is in power-ON.

- High-impedance communication port (CP0 to CP3) when powered down.

 The Communication port pins (CP0 to CP3) attain high impedance when the Neuron Chip is powered down. The eliminates the need for an external relay.
- Built-in low-voltage detection circuit.
 - Prevents incorrect operations and writing errors in the EEPROM during drops in power voltage. The external LVD must be use, if Neuron Chip operated at 20MHz.

Because of the possibility of improper operation at power supply voltages below 4.5V, a low voltage detector (LVD) capability is built in to the chip to assert reset when power falls below the specified voltage.

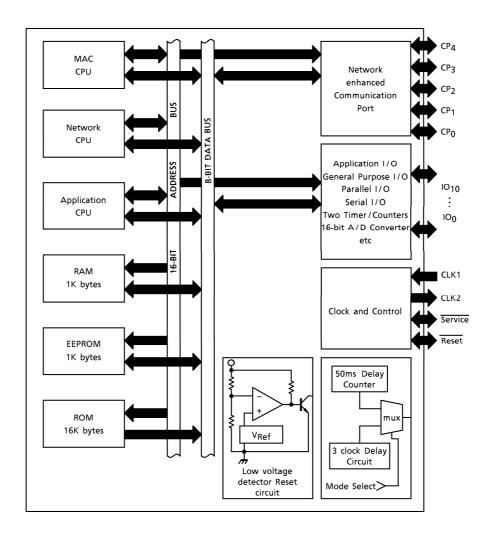
- Firmware version 9.
- Timing for the main I/O objects during 20MHz Neuron Chip operations

I/O MODEL	10MHz TIMING	20MHz TIMING		
Parallel	2.4μs / byte	1.2 μs / byte		
Bitshift	1, 10 or 15kbps	2, 20 or 30kbps		
Magcard	Up to 8334bps	Up to 16668bps		
Magtrack1	Up to 7246bps	Up to 14492bps		
Neurowire Master	1, 10 or 20kbps	2, 20 or 40kbps		
Neurowire Slave	Up to 18kbps	Up to 36kbps		
Serial	600, 1200, 2400 or 4800bps	1200, 2400, 4800 or 9600bps		
Touch	Supported	Not supported		
Frequency Output	Resolution 0.4 to $51.2 \mu s$	Resolution 0.2 to 25.6 μ s		
	Max Range 26.21 to 3355ms	Max Range 13.1 to 1678ms		
Other Timer/Counter	Resolution 0.2 to 25.6 μ s	Resolution 0.1 to 12.8 μ s		
Other Timer/Counter	Max Range 13.1 to 1678ms	Max Range 6.55 to 839ms		

The specifications for the main timers during 20MHz operations are as follows :

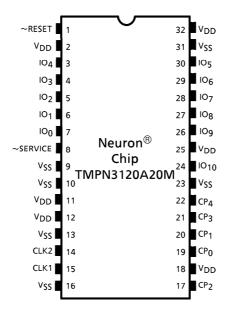
Watchdog Timer	420ms	
Millisecond Timers	1 to 32000 ms	
Second Timers	1 to 65000s	
Delay () Function	1 to 32767 counts	
Get_Tick_Count() Function	409.6μs per count	

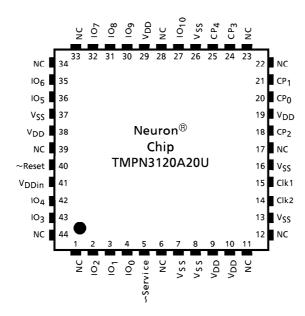
BLOCK DIAGRAM



ITEM	TMPN3120A20M	TMPN3120A20U	
CPU	8-bit CPU×3	8-bit CPU×3	
RAM	1,024 bytes	1,024 bytes	
ROM	16,384 bytes	16,384 bytes	
EEPROM	1,024 bytes	1,024 bytes	
16-bit Timer/Counter	2	2	
External Memory Interface	No	No	
Package	32 pin SOP	μ QFP44pin	

PIN CONNECTION





PIN FUNCTION

PIN No.		PIN				
TMPN3120A20M	TMPN3120A20U	NAME	1/0	PIN FUNCTION		
15	15	CLK1	Input	Oscillator connection, or external clock input.		
14	14	CLK2	Output	Oscillator connection. Leave open when external clock is input to CLK1.		
1	40	~RESET	I/O (built-in pull-up)	Reset pin. (Active low)		
8	5	~SERVICE	I / O (built-in configurable pull-up)	Service pin. Indicator output during operation.		
7~4	4~2, 43	IO ₀ ~IO ₃	1/0	Large current sink capacity (20mA). General I/O port. When the A/D converter is used, pin IO ₃ is reserved for connection of an external resistor.		
3, 30~28	42, 36, 35, 32	10 ₄ ~10 ₇	I / O (built-in configurable pull-up)	General I/O port. One of IO ₄ to IO ₇ can be specified as No.1 timer/counter input. Output signal can be output to IO ₀ . IO ₄ can be used as the No.2 timer/counter input with IO ₁ as output. When using the 16-bit A/D converter, One of IO ₄ to IO ₆ can be used as analog input and then IO ₇ must be attached the external capacitor of proper valve. When the A/D converter is used, pin IO ₇ is reserved for connection of an external capacitor. One or more of pins IO ₄ to IO ₆ may be used as the analog input.		
27, 26, 24	31, 30, 27	10 ₈ ~10 ₁₀	I/O	General I/O port. Can be used for serial communication with other device.		
2, 11, 12, 18, 25, 32	9, 10, 19, 29, 38, 41	V _{DD}	Input	Power input (5.0V Typ.)		
9, 10, 13, 16, 23, 31	7, 8, 13, 16, 26, 37	V _{SS}	Input	Power input (0V GND)		
19, 20, 17, 21, 22	20, 21, 18, 24, 25	CP ₀ ~CP ₄	1/0	Bidirectional port for communications. Supports several communications protocols by specifying mode.		

- (*) The ~SERVICE and IO₄ to IO₇ terminals are programmable pull-ups.
 All V_{DD} terminals must be externally connected.
 All V_{SS} terminals must be externally connected.

MAXIMUM RATINGS $(V_{SS} = 0V, V_{SS} \text{ typ})$

ITEM	SYMBOL	RATING	UNIT
Power Supply Voltage	V_{DD}	-0.3~7.0	V
Input Voltage	VIN	-0.3 to $V_{DD} + 0.3$	٧
Input Voltage CP ₀ -CP ₃	VIN	– 1.2 to V _{DD} + 1.2	٧
Power Dissipation	PD	800	mW
Storage Temperature	T _{stg}	-65∼150	°C

OPERATING CONDITIONS

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Operating Voltage	V_{DD}	4.5	5.0	5.5	V	
Input Voltage (TTL)	V_{IH}	2.0		V_{DD}	V	
Imput voltage (TTL)	V _{IL}	Vss	_	0.8	٧	
Input Voltage (CMOS)	V_{IH}	V _{DD} - 0.8	1	V_{DD}	V	
Imput voltage (CiviO3)	V _{IL}	Vss		0.8	V	
Input Voltage CP ₀ -CP ₃	V _{IH}	_		V _{DD} + 1.0	V	
(differential mode)	V _{IL}	_	_	- 1.0	V	
Operating Frequency	fosc	0.625	_	20	MHz	
Operating Temperature	T _{opr}	- 40	_	85	°C	

ELECTRICAL CHARACTERISTICS

DC characteristic ($V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_{a} = -40 \sim 85$ °C) (Above operating conditions apply unless otherwise states.)

ITEM	SYMBOL	PINS	TEST CONDITION	MIN.	MAX.	UNIT
LOW Level Input Voltage (1)	V _{IL} (1)	$IO_0 \sim IO_{10}$ CP_0 , CP_3 , CP_4 , \sim SERVICE	_	0	0.8	V
LOW Level Input Voltage (2)	V _{IL} (2)	~RESET	_	0	V _{DD} × 0.3	V
HIGH Level Input Voltage (1)	V _{IH} (1)	$IO_0 \sim IO_{10}$ CP_0 , CP_3 , CP_4 , \sim SERVICE	_	2.0	V _{DD}	V
HIGH Level Input Voltage (2)	V _{IH} (2)	~RESET	_	V _{DD} - 0.7	V _{DD}	٧
1004.0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	V = . (1)	100~103	I _{OL} = 20mA	0	0.8	V
LOW Output Voltage (1)	V _{OL} (1)	~SERVICE, ~RESET	I _{OL} = 10mA	0	0.4	
LOW Output Voltage (2)	V _{OL} (2)	CP ₂ , CP ₃	I _{OL} = 40mA	0	1.0	V
LOW Output Voltage (3)	V _{OL} (3)	(Note 1)	I _{OL} = 1.4mA	0	0.4	V
HIGH Output Voltage (1)	V _{OH} (1)	100~103	I _{OH} = -1.4mA	V _{DD} - 0.4	V _{DD}	V
HIGH Output Voltage (2)	V _{OH} (2)	~SERVICE	I _{OH} = - 1.4mA	V _{DD} - 0.4	V _{DD}	V
HIGH Output Voltage (3)	V _{OH} (3)	CP ₂ , CP ₃	I _{OH} = -40mA	V _{DD} - 1.0	V _{DD}	V
HIGH Output Voltage (4)	V _{OH} (4)	(Note 1)	I _{OH} = - 1.4mA	V _{DD} - 0.4	V _{DD}	V
Input Current	IN	(Note 2)	$V_{IN} = V_{SS} \sim V_{DD}$	- 10	10	μΑ
Pull-up Current	I _{PU} (Note 3)	IO ₄ ~IO ₇ ~SERVICE, ~RESET	V _{IN} = 0V	- 30	- 300	μΑ
Current (operating)	I _{DD} (1)	V _{DD}	V _{DD} = 5.5V 20M (no load) 10M		55 30	mA
Current (SLEEP mode)	I _{DD} (2)	v_{DD}	$V_{DD} = 5.5V \text{ (no load)}$	1 –	0.1	mA
Low-voltage Detection Level	V _{LVD}	V _{DD}	_	3.8	4.4	V
Differential Output Voltage	V _{OD}	CP ₂ , CP ₃	I _O = 60mA	1.5	 	V

⁽Note 1) Output voltage characteristics exclude the ~RESET pin and CLK2 pin.

⁽Note 2) Excludes pull-up input pins.

⁽Note 3) The IO₄ to IO₇ and ~SERVICE pins have programmable pull-ups. ~RESET has a fixed pull-up.

- Echelon, Neuron, LON, LonTalk, LonBuilder, NodeBuilder, LONWORKS, 3150, 3120 and LonManager are the registered trade marks of Echelon Corporation, USA.
- The Neuron Chip is manufactured by Toshiba under license from Echelon Corporation, USA. A licensing agreement between the customer and Echelon Corporation must be concluded before purchasing any of the neuron chip products.
- This IC (TMPN3120A20M and TMPN3120A20U) is covered by the patent agreement between Toshiba and Bull Cp8 Inc. Kindly understand that this product cannot be used in IC cards or other portable devices (refer to the definition below).

"PORTABLE DEVICES"

- (I) A portable device defined by ISO standard 7816 as having a width or length of \pm 10mm and a thickness of \pm 3mm.
- (II) A portable device that conforms to the electrical connection placement and shape stipulated by ISO standard 7816 Part 2.
- (III) A pocket-sized portable device in which the ID or history of the holder or the ID or history of the device can be stored as information.

[BULL CP8 patent: America patent number 4,382,279]

 The following patent notice has been issued by Echelon Corporation, USA in relation to the use of the I²C I /O object.

PATENT NOTICE

Echelon's delivery to you of the "I²C Library" does not convey nor imply a right under any I²C patent rights of Philips Electronics N.V. ("Philips") to make, use or sell any product employing such patent rights. Please refer all questions with respect to I²C patents and licenses to Philips at:

Mr. H.B. Schoonheijm Corporate Patents and Trademarks Philips International B.V. P.O. Box 220 5600 MD Eindhoven The Netherlands

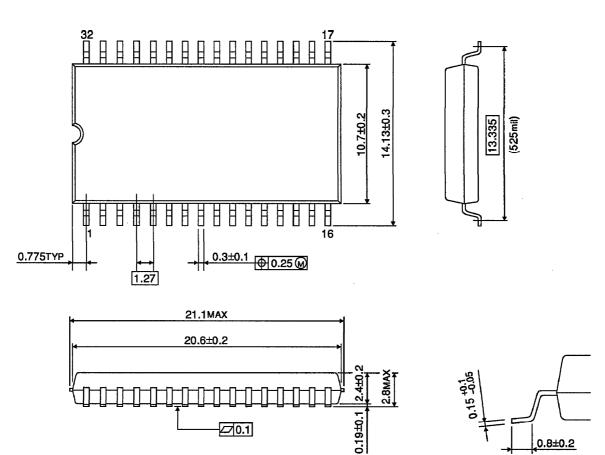
Telephone + 31 40 743479

Facsimile + 31 40 743489

OUTLINE DRAWING

SOP32-P-525-1.27

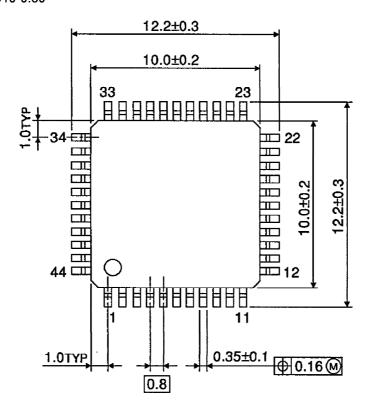
Unit: mm

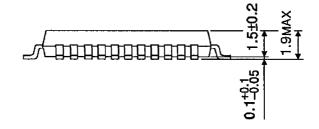


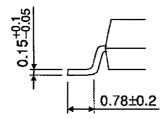
Weight: 1.1g (Typ.)

OUTLINE DRAWING QFP44-P-1010-0.80

Unit: mm







Weight: 0.6g (Typ.)